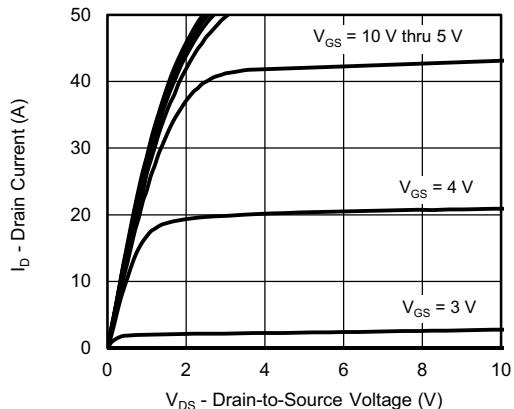
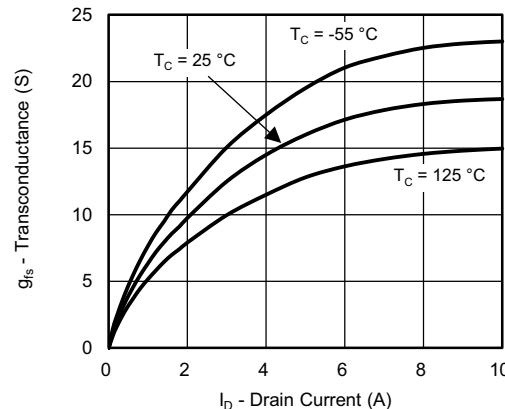
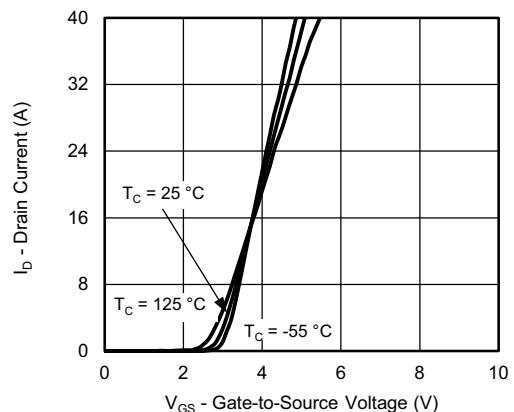
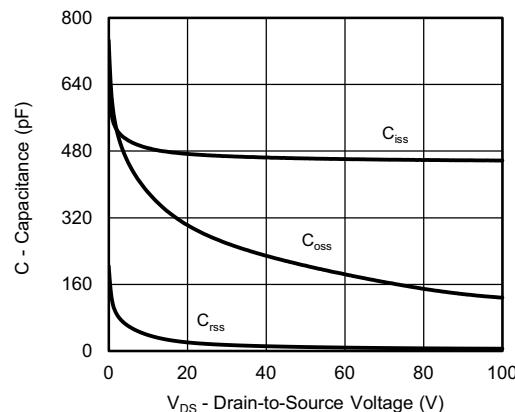
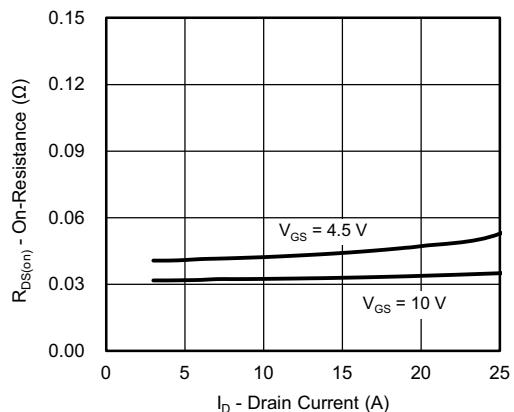
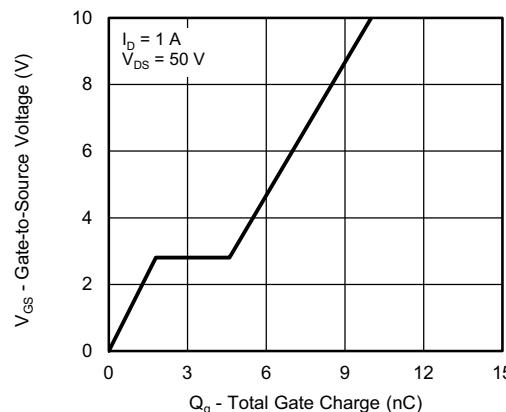


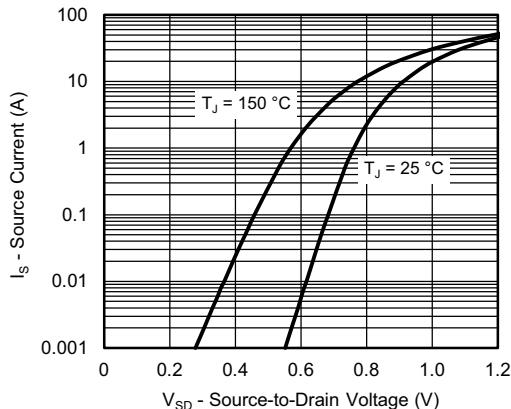
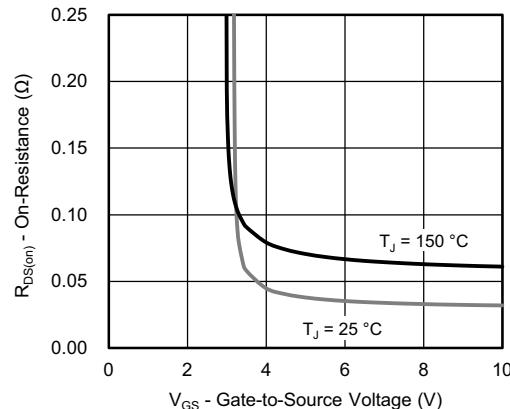
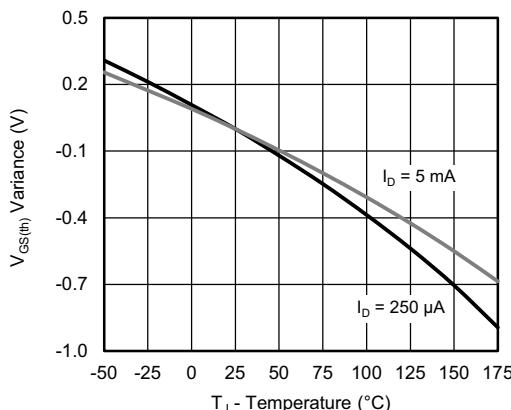
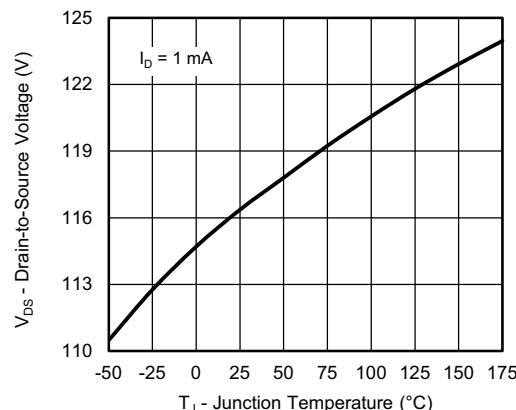
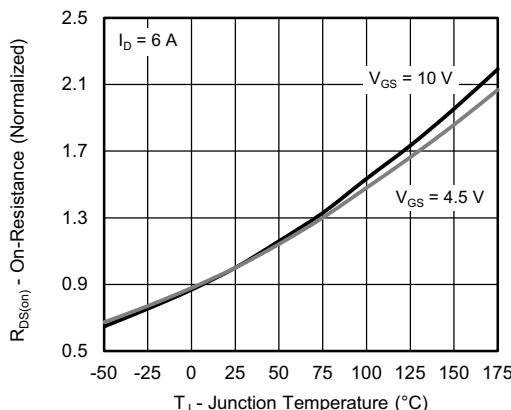
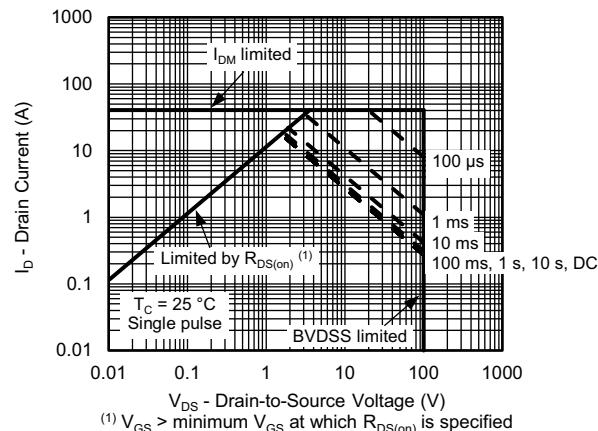
SPECIFICATIONS ($T_C = 25^\circ\text{C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Dynamic ^b								
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 1	-	8	15	ns	
		$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 2	-	12	20		
Rise Time ^c	t_r	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 1	-	3	5		
		$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 2	-	3	5		
Turn-Off Delay Time ^c	$t_{d(off)}$	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 1	-	22	35		
		$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 2	-	28	45		
Fall Time ^c	t_f	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 1	-	21	35		
		$V_{DD} = 50 \text{ V}, R_L = 5 \Omega, I_D \geq 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	N-Ch 2	-	22	35		
Source-Drain Diode Ratings and Characteristics ^b								
Pulsed Current ^a	I_{SM}		N-Ch 1	-	-	40	A	
			N-Ch 2	-	-	80		
Forward Voltage	V_{SD}	$I_F = 6 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch 1	-	0.87	1.2	V	
		$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch 2	-	0.84	1.2		

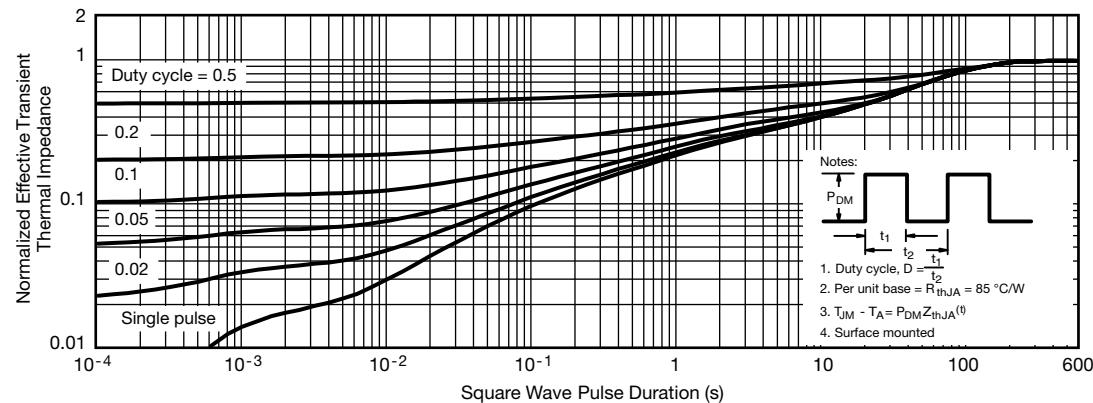
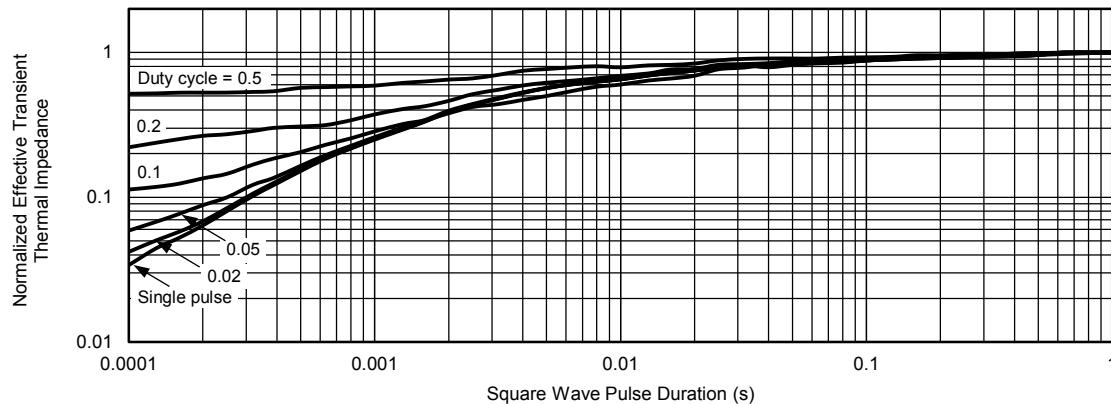
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2 \%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

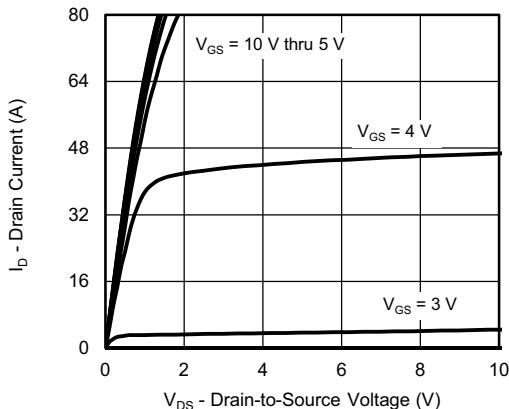
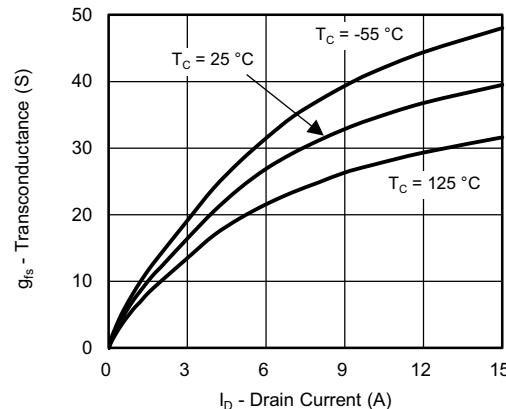
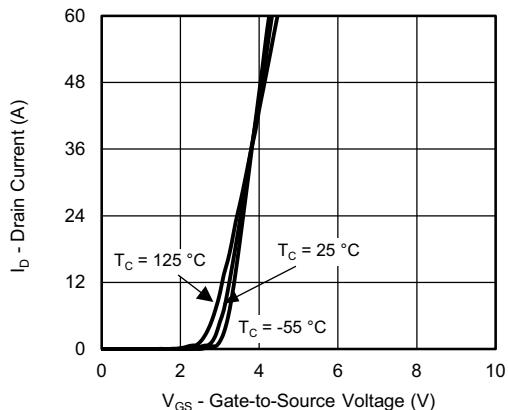
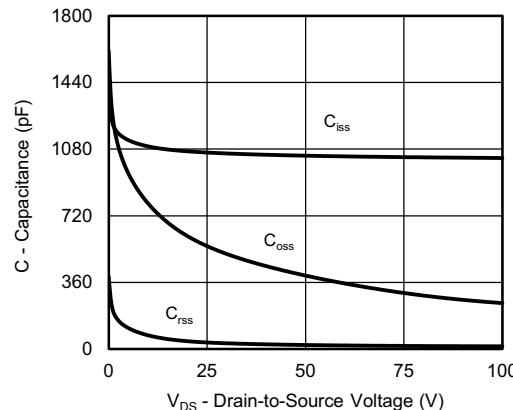
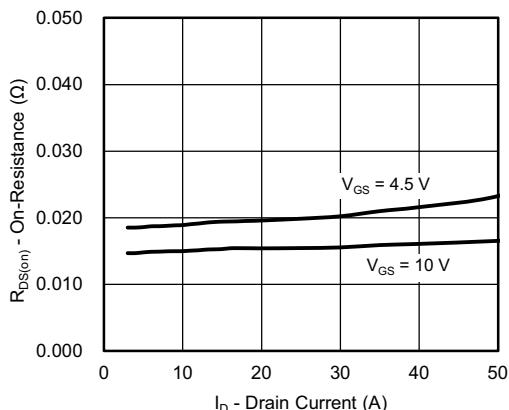
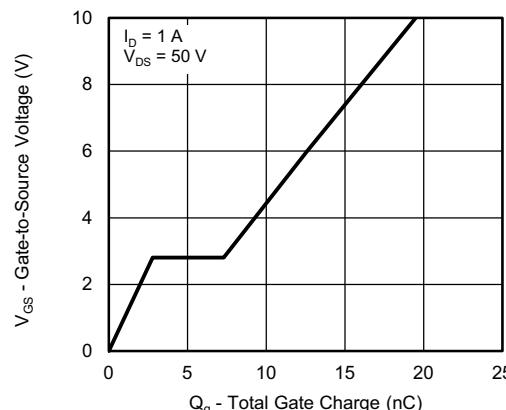
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

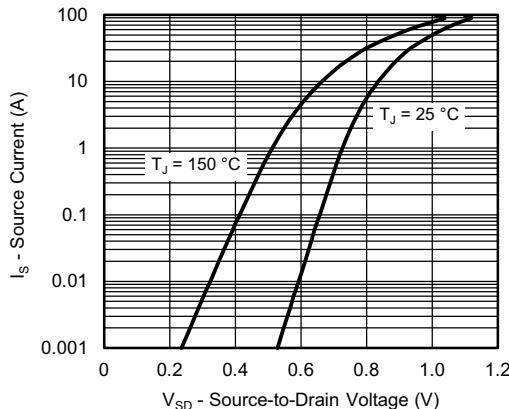
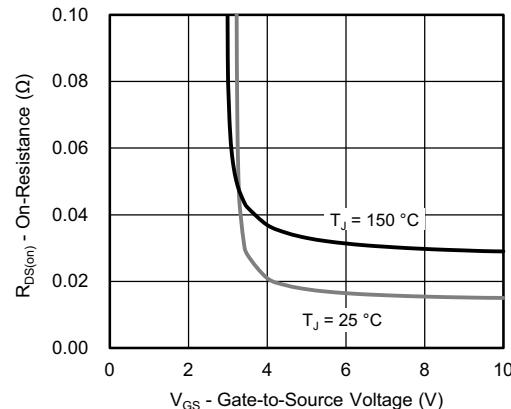
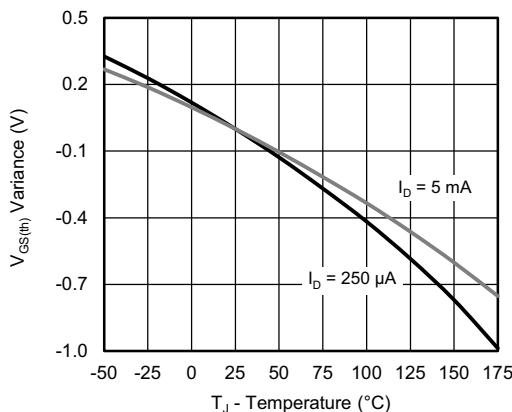
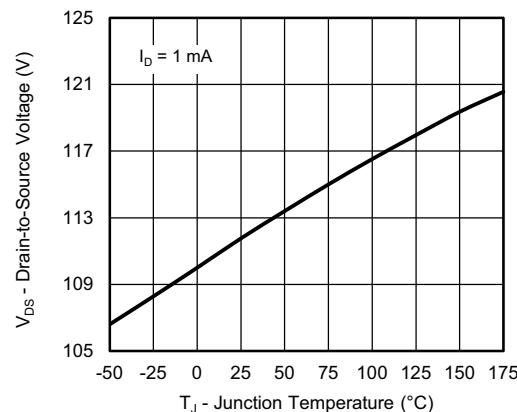
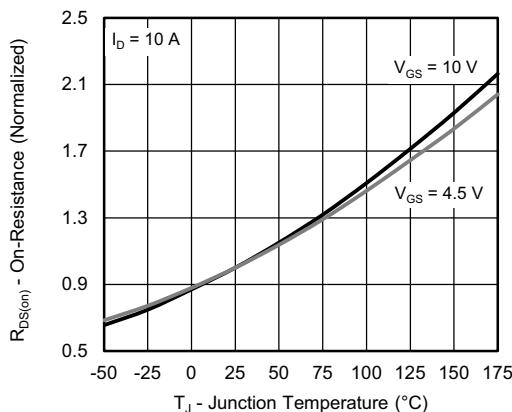
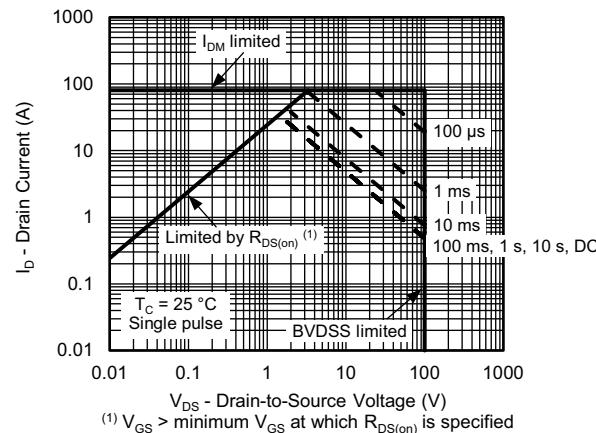
N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Output Characteristics

Transconductance

Transfer Characteristics

Capacitance

On-Resistance vs. Drain Current

Gate Charge

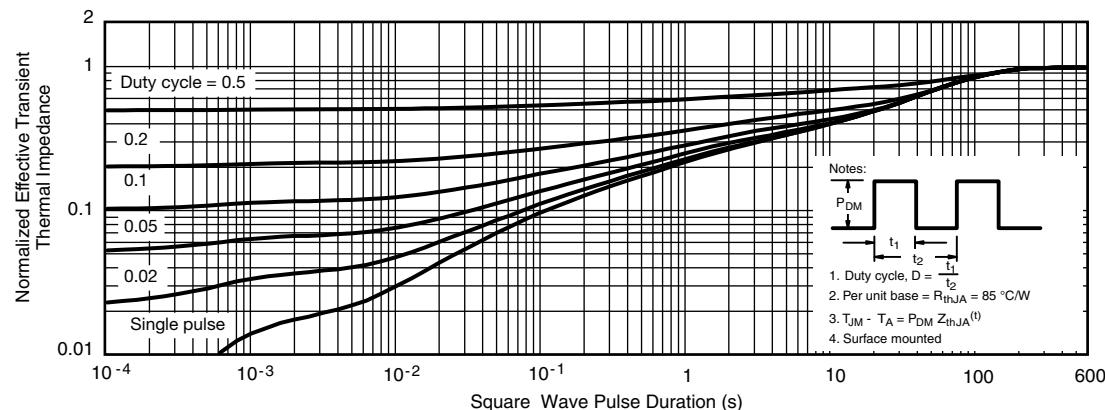
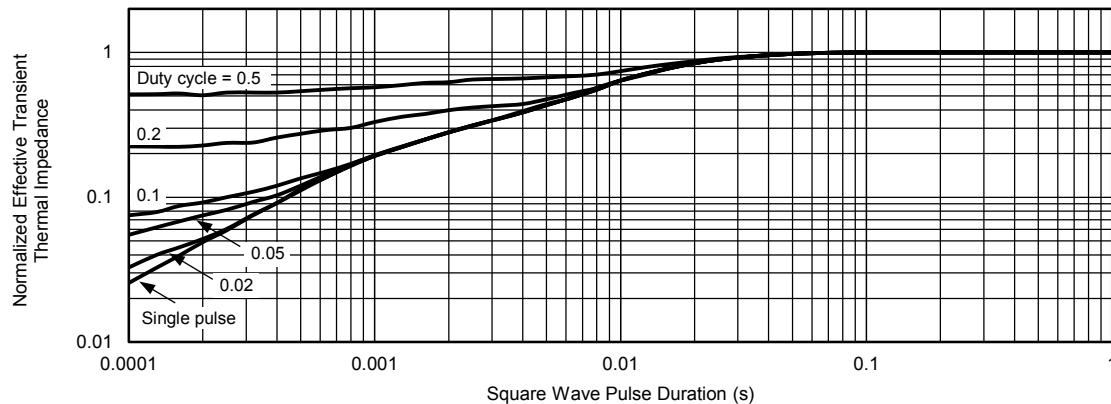
N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Source Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Drain Source Breakdown vs. Junction Temperature

On-Resistance vs. Junction Temperature

Safe Operating Area

N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case
Note

- The characteristics shown in the graph:
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25°C)
- is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Output Characteristics

Transconductance

Transfer Characteristics

Capacitance

On-Resistance vs. Drain Current

Gate Charge

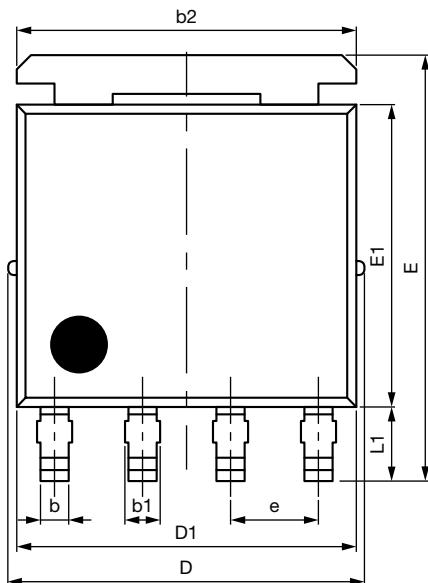
N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Source Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Drain Source Breakdown vs. Junction Temperature

On-Resistance vs. Junction Temperature

Safe Operating Area

N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case
Note

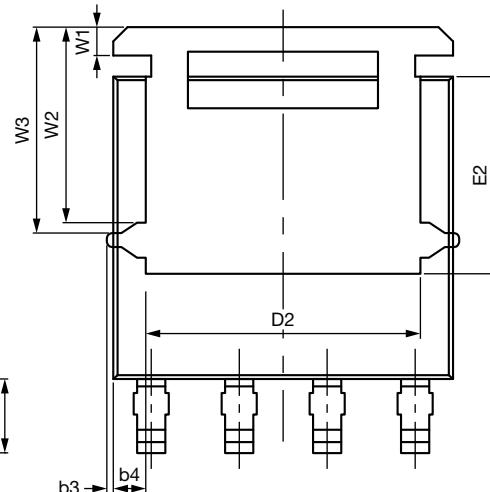
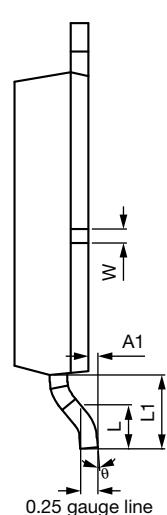
- The characteristics shown in the graph:
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25°C)
- is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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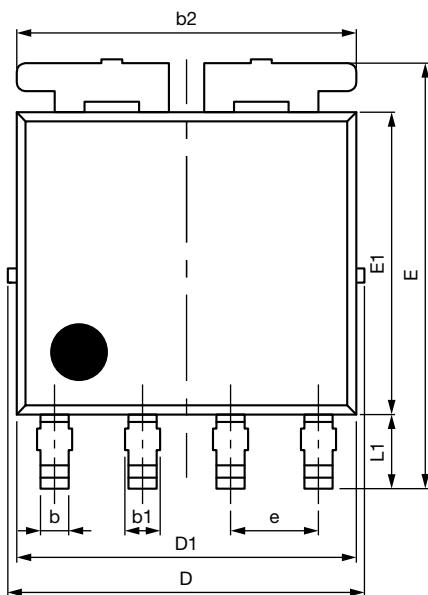
PowerPAK® SO-8L Case Outline 2



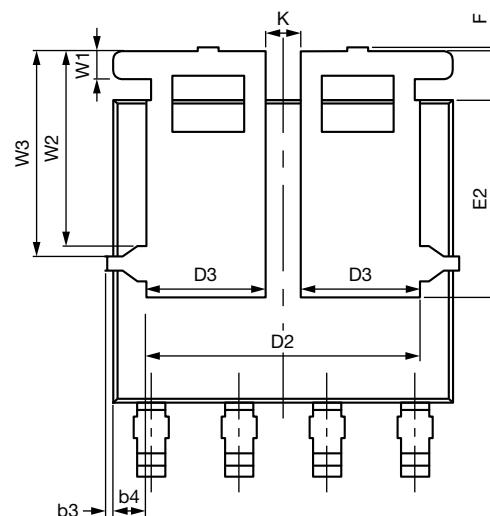
Topside view (single)



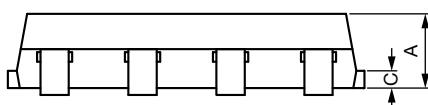
Backside view (single)



Topside view (dual)



Backside view (dual)





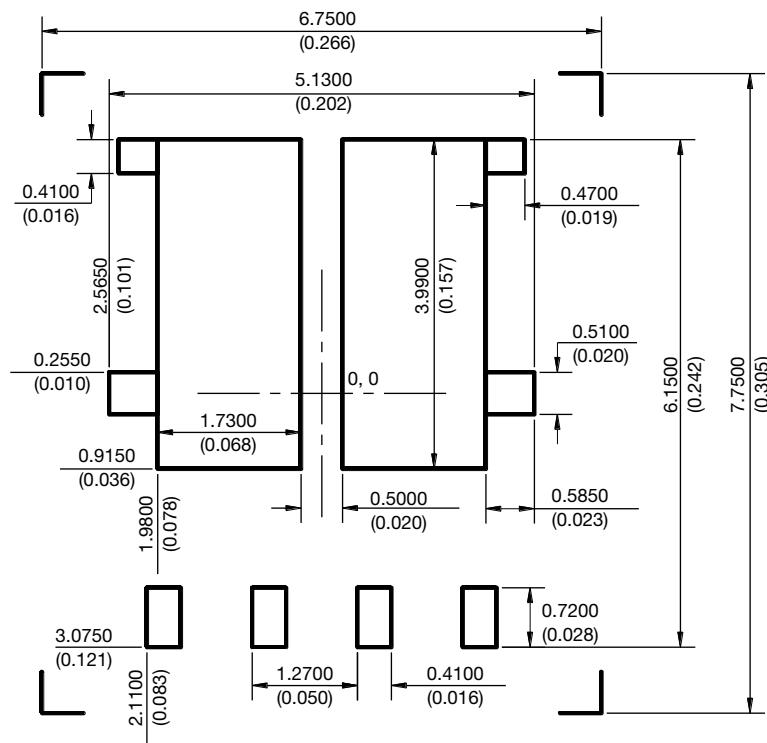
DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.00	1.07	1.14	0.039	0.042	0.045
A1	0.00	-	0.127	0.00	-	0.005
b	0.33	0.41	0.48	0.013	0.016	0.019
b1	0.44	0.51	0.58	0.017	0.020	0.023
b2	4.80	4.90	5.00	0.189	0.193	0.197
b3	0.094			0.004		
b4	0.47			0.019		
c	0.20	0.25	0.30	0.008	0.010	0.012
D	5.00	5.13	5.25	0.197	0.202	0.207
D1	4.80	4.90	5.00	0.189	0.193	0.197
D2	3.86	3.96	4.06	0.152	0.156	0.160
D3	1.63	1.73	1.83	0.064	0.068	0.072
e	1.27 BSC			0.050 BSC		
E	6.05	6.15	6.25	0.238	0.242	0.246
E1	4.27	4.37	4.47	0.168	0.172	0.176
E2	2.75	2.85	2.95	0.108	0.112	0.116
F	-	-	0.15	-	-	0.006
L	0.62	0.72	0.82	0.024	0.028	0.032
L1	0.92	1.07	1.22	0.036	0.042	0.048
K	0.51			0.020		
W	0.23			0.009		
W1	0.41			0.016		
W2	2.82			0.111		
W3	2.96			0.117		
θ	0°	-	10°	0°	-	10°

ECN: C21-1498-Rev. C, 01-Nov-2021

DWG: 6044

Note

- Millimeters will govern

RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL


Recommended Minimum Pads
Dimensions in mm (inches)
Keep-out 6.75 (0.266) x 7.75 (0.305)



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